

FX 03020 US

OSP-14827

US 1/2 1/2

Docket No.

Armstrong, Westerman &amp; Hattori, LLP

**DECLARATION FOR U.S. PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

SOLVENT-FREE MOISTURE-CURABLE HOT MELT URETHANE RESIN COMPOSITION

the specification of which is attached hereto unless the following is checked

☐ was filed on \_\_\_\_\_ as United States Application Number \_\_\_\_\_ or PCT International Application Number \_\_\_\_\_ and was amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) - (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed.

**Priority Claimed**

(List prior foreign applications. See note A below)

2002-282885Japan27/09/2002☒ Yes ☐ No

(Number)

(Country)

(Day/Month/Year Filed)

(Number)

(Country)

(Day/Month/Year Filed)

☐ Yes ☐ No

(Number)

(Country)

(Day/Month/Year Filed)

☐ Yes ☐ No

(Number)

(Country)

(Day/Month/Year Filed)

☐ Yes ☐ No

(See note B below)

☐ See attached list for additional prior foreign applications

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

**Status**

(List prior U.S. Applications)

(Application Serial No.)

(Filing Date)

☐ Patented ☐ Pending ☐ Abandoned

(Application Serial No.)

(Filing Date)

☐ Patented ☐ Pending ☐ Abandoned

(Application Serial No.)

(Filing Date)

☐ Patented ☐ Pending ☐ Abandoned

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agent(s) to prosecute this application and to transact all business in  
with:



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statements made herein of my own knowledge are true and that all statements made on  
are believed to be true; and further that these statements were made with the knowledge that  
ments and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the  
Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any  
issued thereon.

(See note C)

Full name of sole or first inventor (given name, family name) Yukihiko Minamida  
Inventor's signature Yukihiko Minamida Date September 16, 2003  
Residence Osaka, Japan Citizenship Japan  
Post Office Address 110-37, Kami, Sakai-shi, Osaka, Japan

Full name of second inventor (given name, family name) Masayoshi Imanaka  
Inventor's signature Masayoshi Imanaka Date September 16, 2003  
Residence Osaka, Japan Citizenship Japan  
Post Office Address 4-4, Terakado-cho 2-chome, Izumi-shi, Osaka, Japan

Full name of third inventor (given name, family name) Kojiro Tanaka  
Inventor's signature Kojiro Tanaka Date September 16, 2003  
Residence Osaka, Japan Citizenship Japan  
Post Office Address 19-14, Matsunohama-cho, Izumiotsu-shi, Osaka, Japan

Full name of fourth inventor (given name, family name) \_\_\_\_\_  
Inventor's signature \_\_\_\_\_ Date \_\_\_\_\_  
Residence \_\_\_\_\_ Citizenship \_\_\_\_\_  
Post Office Address \_\_\_\_\_

Full name of fifth inventor (given name, family name) \_\_\_\_\_  
Inventor's signature \_\_\_\_\_ Date \_\_\_\_\_  
Residence \_\_\_\_\_ Citizenship \_\_\_\_\_  
Post Office Address \_\_\_\_\_